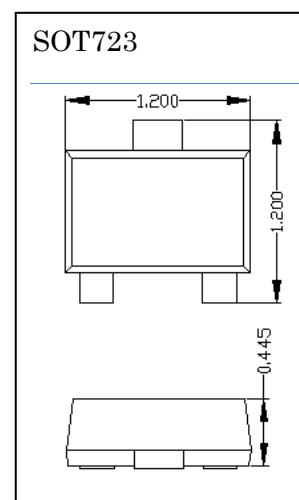
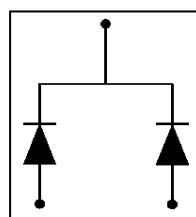


- ◇ High Conductance
- ◇ Low Current Leakage
- ◇ Small Outline Surface Mount Package
- ◇ RoHS compliant / Green EMC

Device	Device Marking
BAT54CM	KL3

Circuit Diagram



MAXIMUM RATINGS (Ta = 25 °C)

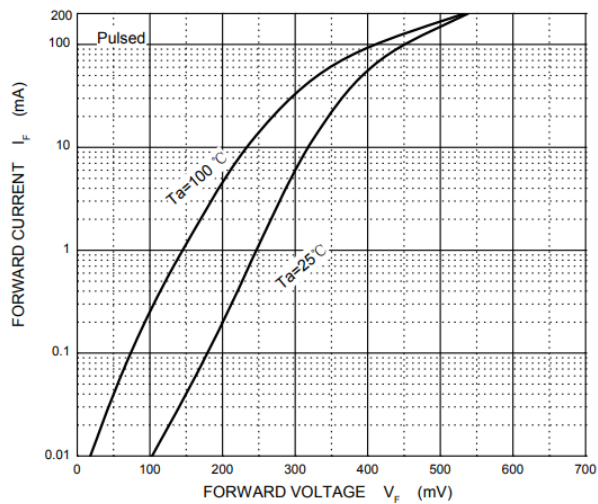
Symbol	Parameter	Value	Units
V_{RRM}	Peak Repetitive Reverse Voltage	30	V
V_{RWM}	Working Peak Reverse Voltage	30	V
$V_{R(RMS)}$	RMS Reverse Voltage	21	V
I_O	Average Forward Current	200	mA
I_{FSM}	Non-repetitive Peak Forward Surge Current @ t=8.3ms	600	mA
I_{FRM}	Repetitive Peak Forward Current @ t≤1s, δ≤0.5	300	mA
P_D	Power Dissipation	150	mW
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	667	°C/W
T_j	Junction Temperature	125	°C
T_{stg}	Storage Temperature	-55~+150	°C

ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

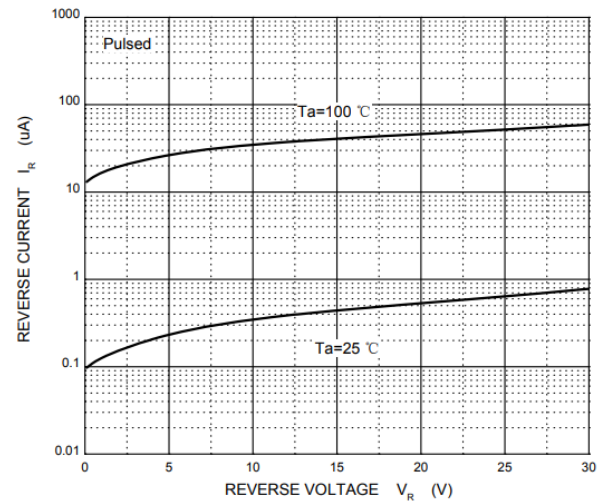
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$V_{(BR)}$	Reverse voltage	$I_R=100 \mu A$	30			V
I_R	Reverse current	$V_R=25V$			2	uA
V_F	Forward voltage	$I_F=0.1mA$			0.24	V
		$I_F=1mA$			0.32	
		$I_F=10mA$			0.4	
		$I_F=30mA$			0.5	
		$I_F=100mA$			1	
C_{tot}	Total capacitance	$V_R=1V, f=1.0MHz$			10	pF
T_{rr}	Reverse recovery time	$I_F=I_R=10mA, I_{R(REO)}=1mA$			5	nS

TYPICAL CHARACTERISTICS

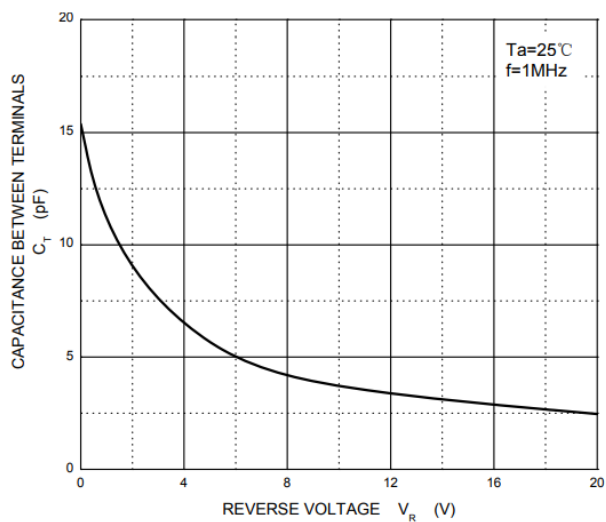
Forward Characteristics



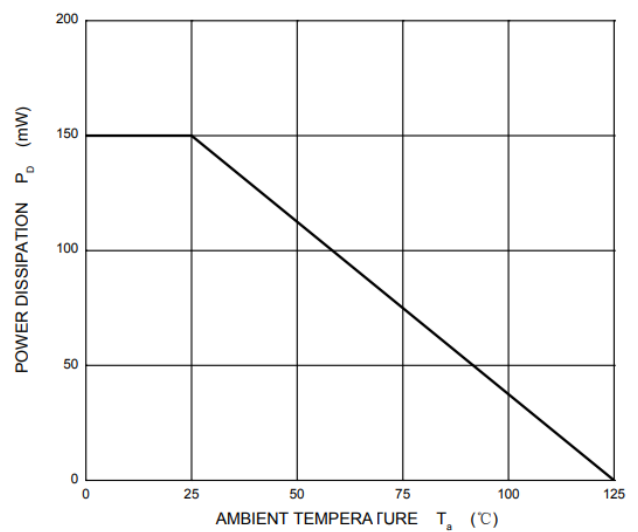
Reverse Characteristics



Capacitance Characteristics



Power Derating Curve

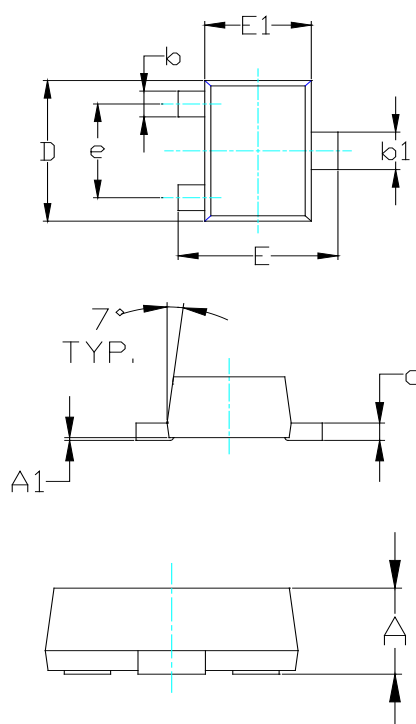


ORDERING INFORMATION

Device	Package	Shipping	Tape wide	Emboss pitch	Tape specification	Notes
BAT54CM	SOT723	Tape & Reel 8000pcs /7" Reel	8mm	4mm	Conductive	

PACKAGE DIMENSIONS

Package outline : SOT723



SYMBOL	DIMENSIONS IN MILLIMETER	
	MIN	MAX
A	0.430	0.500
A1	0.000	0.050
b	0.170	0.270
b1	0.270	0.370
c	0.080	0.150
D	1.150	1.250
E	1.150	1.250
E1	0.750	0.850
e	0.800 TYP.	
θ	0°	7°

Notice:

1. Lead plating: Pb free solder
2. Lead thickness includes solder plating
3. Lead frame: CAC-5
4. Other Tolerance: ± 0.05
5. Dimensions are exclusive of Burrs, Mold Flash and Tie Bar extrusions
6. Unit: mm